

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	587	"5625526" "6444033" "5591269" "5822171" "5926947" "6038763" "6128810" "6134769" "6949165" "6295194" "6304424" "6370005" "5426276" "4451976" "4808053" "4899437" "5024430" "5029499" "5248058" "5320010" "5337465" "5473855" "5841091" "5857127" "6029814" "6055892" "6134998" "6163005" "6179190" "6182731" "6257108" "6427554" "5280156" "5460684" "5618350" "5665166" "5708250" "5745332" "5751537" "5764471" "5777838" "5801915" "5835335" "5847918" "5868848" "5886863" "5923521" "5982607" "5998931" "6008549"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 16:39
L2	68	"6677167" "6646233" "5625526" "5969934" 10/650916	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 17:18
L3	6	2 and (thermal adj spray\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 17:20
L4	6	3 and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 17:21
L5	12	2 and substrate and spray\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 17:29
L6	12	"6677167" "6646233"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 17:39

L12	3	11 and (substrate wafer die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 18:00
L13	3	12 and (electrostatic adj chuck)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 18:02
L14	3	8 and (dielectric adj (band bed coat cover film lamina overlay sheet stratum substratum thickness tier zone))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 18:07
L15	3	14 and (substrate wafer die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 18:08
L16	3	15 and (electrostatic adj chuck)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 18:08
L19	3	16 and (lower adj (side border bottom boundary elevation face flank front limit margin part perimeter posture rear rim sector surface top view wing))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 18:24
S1	14	"5618350" "6376808"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/15 14:16

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	72	(esc or (electrostatic adj chuck)) and (electrode\$1 with spring)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:30
L2	50	(esc or (electrostatic adj chuck)) and (electrode\$1 with spring) and method	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:24
L3	15	2 and spray\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:24
L4	1	3 and jig	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:25
L5	15	3 and form\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:26
L6	10	5 and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:26
L7	10	6 and dielectric	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:26
L8	7	7 and (brazing or bonding or soldering)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:27

L9	1686	(esc or (electrostatic adj chuck)) and (method with chuck)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:30
L10	57	9 and (layer same dielectric same spray\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:31
L11	8	10 and (internal with electrode\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:31